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1c843 U.S. PTO

NON-PROVISIONAL APPLICATION FOR U. S. PATENT UNDER 37 CFR 1.53(b)
TRANSMITTAL FORM

Attorney Docket No. TI-30736

Assistant Commissioner for Patents
Washington, D. C. 20231

Sir:

Transmitted herewith for filing is the
patent application of:

Inventor(s): **Albert G. Cabintos**

"EXPRESS MAILING" Mailing Label No.

EL858166632US. Date of Deposit: **October 24, 2001.**

I hereby certify that this paper is being deposited with the
U.S. Postal Service Express Mail Post Office to Addressee
Service under 37 CFR 1.10 on the date shown above and is
addressed to the Assistant Commissioner for Patents,
Washington, D.C. 20231.

Emily C. Chantry

Date

For: **Wafer Probe Assemblage With Spring Enhanced Needles.**

Enclosed are:

- 2 Sheets of formal drawings and 20 pages of Specification (including Abstract)
X A Declaration/Power of Attorney
X Assignment with form PTO 1595

Please amend the specification by inserting before the first line the sentence:

This application claims priority under 35 USC § 119 based upon **Provisional Patent Application
number 60/244,451, filed 10/31/00.**

FEE CALCULATION					FEE
	NUMBER		NUMBER EXTRA	RATE	BASIC FEE \$ 740.00
Total Claims	18	-20 =	0	X \$18 =	\$0.00
Independent Claims	3	- 3 =	0	X \$84 =	\$0.00
Total Filing Fee					\$740.00

Please charge **Deposit Account No. 20-0668** in the amount of the Total Fees set forth. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 20-0668. **This form is submitted in triplicate.**

All correspondence related to this application may be addressed to the undersigned at Godwin Gruber, P.C. 801 E. Campbell Rd. Suite 655, Richardson, TX 75081.

Date: **October 24, 2000**

Gary C. Honeycutt
Gary C. Honeycutt
Registration No. 20,250

1c955 U.S. PTO
10/001386
10/25/01

G O D W I N G R U B E R

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October 24, 2001

VIA EXPRESS MAIL **EL858166632US**

Assistant Commissioner for Patents
Washington, D.C. 20231

Re: Patent Application For:
 WAFER PROBE ASSEMBLAGE WITH SPRING ENHANCED NEEDLES
 Attorney Docket No. TI-30736
 Our File: 50000.2160

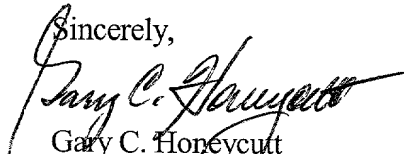
Dear Sir:

Enclosed for filing please find the following items relating to the above-identified application:

- (1) Non-Provisional Application/Fee Authorization/transmittal Form ;
- (2) Declaration, and Power of Attorney;
- (3) Recordation Form Cover Sheet with Assignment;
- (4) Specifications and Formal Drawings; and
- (5) Postcards.

Please charge **Deposit Account No. 20-0668** in the amount of the total fees set forth. The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to **Deposit Account No. 20-0668**.

Please file the application and return the date-stamped postcard to the corresponding addresses as indicated. In the meantime, if you have any questions or comments concerning this matter, please call the undersigned. Otherwise, please accept the enclosed.

Sincerely,

Gary C. Honeycutt
Reg. No. 20,250

GCH/ecc

Encls.

Cc: Lawrence Bassuk, Texas Instruments Incorporated